

LF198QML Monolithic Sample-and-Hold Circuits

Check for Samples: LF198QML

FEATURES

- Operates from ±5V to ±18V supplies
- Less than 10 µs acquisition time
- TTL, PMOS, CMOS compatible logic input
- 0.5 mV typical hold step at $C_h = 0.01 \mu F$
- Low input offset
- 0.002% gain accuracy
- Low output noise in hold mode
- Input characteristics do not change during hold mode
- High supply rejection ratio in sample or hold
- Wide bandwidth

DESCRIPTION

The LF198 is a monolithic sample-and-hold circuit which utilizes BI-FET technology to obtain ultra-high dc accuracy with fast acquisition of signal and low droop rate. Operating as a unity gain follower, dc gain accuracy is 0.002% typical and acquisition time is as low as 6 µs to 0.01%. A bipolar input stage is used to achieve low offset voltage and wide bandwidth. Input offset adjust is accomplished with a single pin, and does not degrade input offset drift. The wide bandwidth allows the LF198 to be included inside the feedback loop of 1 MHz op amps without having stability problems. Input impedance of $10^{10}\Omega$ allows high source impedances to be used without degrading accuracy.

P-channel junction FET's are combined with bipolar devices in the output amplifier to give droop rates as low as 5 mV/min with a 1 µF hold capacitor. The JFET's have much lower noise than MOS devices used in previous designs and do not exhibit high temperature instabilities. The overall design specifies no feed-through from input to output in the hold mode, even for input signals equal to the supply voltages.

Logic inputs on the LF198 are fully differential with low input current, allowing direct connection to TTL, PMOS, and CMOS. Differential threshold is 1.4V. The LF198 will operate from ±5V to ±18V supplies.

Connection Diagrams

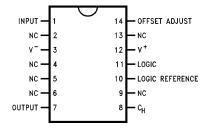


Figure 1. Small-Outline Package (CGLA) See Package Number NAC0014A

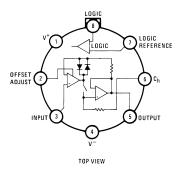


Figure 2. Metal Can Package (TO-99) See Package Number LMC0008C

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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Typical Connection and Performance Curve

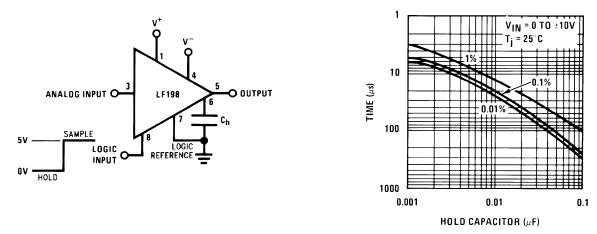
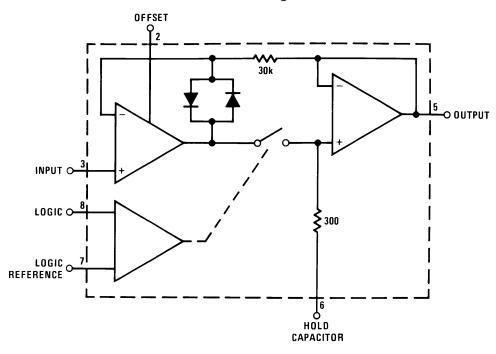


Figure 3.

Figure 4. Acquisition Time

Functional Diagram



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Absolute Maximum Ratings (1)

Supply Voltage	±18V
Power Dissipation (Package Limitation) (2)	500 mW
Operating Ambient Temperature Range	−55°C to +125°C
Maximum Junction Temperature (T _{Jmax})	+150°C
Input Voltage	Equal to Supply Voltage
Logic To Logic Reference Differential Voltage (3)	+7V, −30V
Output Short Circuit Duration	Indefinite
Hold Capacitor Short Circuit Duration	10 sec
Lead Temperature (Soldering, 10 sec.)	260°C
Thermal Resistance, θ_{JA}	
Metal Can (Still Air at 0.5W)	160°C/W
Metal Can (500 LF/Min Air at 0.5W)	84°C/W
Ceramic SOIC (Stil Air at 0.5W)	140°C/W
Ceramic SOIC (500 LF/Min Air Flow at 0.5W)	95°C/W
$\theta_{ m JC}$	
Metal Can	48°C/W
Ceramic SOIC	20°C/W
Package Weight (typical)	
Metal Can	TBD
Ceramic SOIC	415mg
ESD Tolerance ⁽⁴⁾	500V

- (1) "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For specifications and test conditions, see the Electrical Characteristics. The specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions
- (2) The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX}, θ_{JA}, and the ambient temperature, T_A. The maximum allowable power dissipation at any temperature is P_D = (T_{JMAX} T_A)/θ_{JA}, or the number given in the Absolute Maximum Ratings, whichever is lower.
- Maximum Ratings, whichever is lower. .

 (3) Although the differential voltage may not exceed the limits given, the common-mode voltage on the logic pins may be equal to the supply voltages without causing damage to the circuit. For proper logic operation, however, one of the logic pins must always be at least 2V below the positive supply and 3V above the negative supply.
- (4) Human body model, 100pF discharged through 1.5KΩ

Quality Conformance Inspection

Mil-Std-883, Method 5005 — Group A

Subgroup	Description	Temperature (°C)
1	Static tests at	+25°C
2	Static tests at	+125°C
3	Static tests at	−55°C
4	Dynamic tests at	+25°C
5	Dynamic tests at	+125°C
6	Dynamic tests at	−55°C
7	Functional tests at	+25°C
8A	Functional tests at	+125°C
8B	Functional tests at	−55°C
9	Switching tests at	+25°C
10	Switching tests at	+125°C
11	Switching tests at	−55°C

Product Folder Links: LF198QML



Electrical Characteristics

The following specifications apply unless otherwise specified.

 $V_{CC} = \pm 15 \text{V}$, $R_L = 10 \text{K}\Omega$, $V_{IN} = 0 \text{V}$, $C_{HOLD} = 0.01 \ \mu\text{F}$, Logic Reference Pin = 0V, Logic Pin = 4V

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub- groups
I _{CC} +	Positive Supply Current	45\/ \/ 45\/			5.5	mA	1, 2
		$+V_{CC} = 15V, -V_{CC} = -15V$			6.5	mA	3
		+V _{CC} = 18V, -V _{CC} = -18V, Mode =			5.5	mA	1, 2
		"Sample"			6.5	mA	3
		+V _{CC} = 18V, -V _{CC} = -18V, Mode =			5.5	mA	1, 2
		"Hold"			6.5	mA	3
lcc-	Negative Supply Current	+V _{CC} = 15V, -V _{CC} = -15V		-5.5		mA	1, 2
		+vcc = 13v, -vcc = -13v		-6.5		mA	3
		$+V_{CC} = 18V, -V_{CC} = -18V, Mode =$		-5.5		mA	1, 2
		"Sample"		-6.5		mA	3
		+V _{CC} = 18V, -V _{CC} = -18V, Mode =		-5.5		mA	1, 2
		"Hold"		-6.5		mA	3
V_{OS}	Input Offset Voltage	$+V_{CC} = 3V, -V_{CC} = -7V$		-3.0	3.0	mV	1
		1,400 = 0,400 = 1,400		-5.0	5.0	mV	2, 3
		+V _{CC} = 15V, -V _{CC} = -15V		-3.0	3.0	mV	1
		1 vcc = 13v, -vcc = -13v		-5.0	5.0	mV	2, 3
		+V _{CC} = 3.5V, -V _{CC} = -26.5V		-3.0	3.0	mV	1
		1 V CC = 0.0 V , V CC = -20.0 V		-5.0	5.0	mV	2, 3
		+V _{CC} = 18V, -V _{CC} = -18V		-3.0	3.0	mV	1
		1 4 6 6 - 10 4 4 6 6 - 10 4		-5.0	5.0	mV	2, 3
		+V _{CC} = 3.5V, -V _{CC} = -32.5V		-3.0	3.0	mV	1
		1 V CC = 0.0 V , V CC = -02.0 V		-5.0	5.0	mV	2, 3
		+V _{CC} = 26.5V, -V _{CC} = -3.5V		-3.0	3.0	mV	1
		7 VCC = 20.3 V, - VCC = -3.3 V		-5.0	5.0	mV	2, 3
		$+V_{CC} = 32.5V, -V_{CC} = -3.5V, Logic$		-3.0	3.0	mV	1
		= 2.5V		-5.0	5.0	mV	2, 3
		+V _{CC} = 7V, -V _{CC} = -3V		-3.0	3.0	mV	1
		+vcc = 7 v, -vcc = -3 v		-5.0	5.0	mV	2, 3
l _{IB}	Input Bias Current	$+V_{CC} = 3V, -V_{CC} = -7V$		-25	25	nA	1
		1 V CC = 3 V , - V CC = - 7 V		-75	75	nA	2, 3
		+V _{CC} = 15V, -V _{CC} = -15V		-25	25	nA	1
		+vCC = 13v, -vCC = -13v		-75	75	nA	2, 3
		+V _{CC} = 3.5V, -V _{CC} = -32.5V		-25	25	nA	1
		+VCC = 3.3V, -VCC = -32.3V		-75	75	nA	2, 3
		+V _{CC} = 32.5V, -V _{CC} = -3.5V		-25	25	nA	1
		. vCC = 32.3v, -vCC = -3.3v		-75	75	nA	2, 3
		+V _{CC} = 7V, -V _{CC} = -3V		-25	25	nA	1
		. vcc - , v, -vccov		-75	75	nA	2, 3
Leak(Cap)	Leakage Current into Hold	$+V_{CC} = 3V, -V_{CC} = -7V$	See (1)	-100	100	pA	1
	Capacitor	$+V_{CC} = 3.5V, -V_{CC} = -32.5V$		-100	100	pA	1
		$+V_{CC} = 32.5V, -V_{CC} = -3.5V$	See (1)	-100	100	pA	1
		$+V_{CC} = 7V, -V_{CC} = -3V$		-100	100	pА	1

⁽¹⁾ Leakage current is measured at a junction temperature of 25°C. The effects of junction temperature rise due to power dissipation or elevated ambient can be calculated by doubling the 25°C value for each 11°C increase in chip temperature. Leakage is specified over full input signal range.

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Electrical Characteristics (continued)

The following specifications apply unless otherwise specified.

 $V_{CC} = \pm 15 \text{V}$, $R_L = 10 \text{K}\Omega$, $V_{IN} = 0 \text{V}$, $C_{HOLD} = 0.01 \ \mu\text{F}$, Logic Reference Pin = 0V, Logic Pin = 4V

Hold Step Gain Error Input Impedance	$+V_{CC} = 15V - V_{CC} = -15V$ $+V_{CC} = 3.5V, -V_{CC} = -26.5V$ $+V_{CC} = 26.5V, -V_{CC} = -3.5V$ $+V_{CC} = 7V, -V_{CC} = -3V$ $+V_{CC} = 3.5V, -V_{CC} = -26.5V$ $+V_{CC} = 32.5V, -V_{CC} = -3.5V$ $+V_{CC} = 26.5V, -V_{CC} = -3.5V$	See (2) See(2) See(2)	-2.0 -5.6 -2.5 -5.6 -2.5 -5.6	2.0 5.6 2.5 5.6 2.5 5.6 0.02 0.06 0.00 5 0.02 0.00	mV mV mV mV mV % %	1 2, 3 1 2, 3 1 2, 3 1 2, 3
	$+V_{CC} = 3.5V, -V_{CC} = -26.5V$ $+V_{CC} = 26.5V, -V_{CC} = -3.5V$ $+V_{CC} = 7V, -V_{CC} = -3V$ $+V_{CC} = 3.5V, -V_{CC} = -26.5V$ $+V_{CC} = 32.5V, -V_{CC} = -3.5V$		-2.5 -5.6 -2.5	2.5 5.6 2.5 5.6 0.02 0.06 0.00 5	mV mV mV % %	1 2, 3 1 2, 3 1 2, 3
	$+V_{CC} = 26.5V, -V_{CC} = -3.5V$ $+V_{CC} = 7V, -V_{CC} = -3V$ $+V_{CC} = 3.5V, -V_{CC} = -26.5V$ $+V_{CC} = 32.5V, -V_{CC} = -3.5V$		-5.6 -2.5	5.6 2.5 5.6 0.02 0.06 0.00 5	mV mV mV % %	2, 3 1 2, 3 1 2, 3
	$+V_{CC} = 26.5V, -V_{CC} = -3.5V$ $+V_{CC} = 7V, -V_{CC} = -3V$ $+V_{CC} = 3.5V, -V_{CC} = -26.5V$ $+V_{CC} = 32.5V, -V_{CC} = -3.5V$	See ⁽²⁾	-2.5	2.5 5.6 0.02 0.06 0.00 5	mV mV % %	1 2, 3 1 2, 3
	$+V_{CC} = 7V$, $-V_{CC} = -3V$ $+V_{CC} = 3.5V$, $-V_{CC} = -26.5V$ $+V_{CC} = 32.5V$, $-V_{CC} = -3.5V$	See ⁽²⁾		5.6 0.02 0.06 0.00 5 0.02	mV % %	2, 3 1 2, 3
	$+V_{CC} = 7V$, $-V_{CC} = -3V$ $+V_{CC} = 3.5V$, $-V_{CC} = -26.5V$ $+V_{CC} = 32.5V$, $-V_{CC} = -3.5V$		-5.6	0.02 0.06 0.00 5 0.02	% % %	1 2, 3
	+V _{CC} = 3.5V, -V _{CC} = -26.5V +V _{CC} = 32.5V, -V _{CC} = -3.5V			0.06 0.00 5 0.02	%	2, 3
nput Impedance	+V _{CC} = 3.5V, -V _{CC} = -26.5V +V _{CC} = 32.5V, -V _{CC} = -3.5V			0.00 5 0.02	%	1
nput Impedance	+V _{CC} = 32.5V, -V _{CC} = -3.5V			5 0.02		
nput Impedance					%	
nput Impedance				0.00		2, 3
nput Impedance	+V _{CC} = 26.5V, -V _{CC} = -3.5V			5	%	1
nput Impedance	+V _{CC} = 26.5V, -V _{CC} = -3.5V			0.06	%	2, 3
nput Impedance				0.00 5	%	1
nput Impedance				0.02	%	2, 3
Input Impedance	+V _{CC} = 8V, -V _{CC} = -28V		10.0		GΩ	1
	1 V CC = 0 V , V CC = 20 V		8.0		GΩ	2, 3
	+V _{CC} = 28V, -V _{CC} = -8V		10.0		GΩ	1
	1 VCC = 20 V, - VCC = - 0 V		8.0		GΩ	2, 3
Output Impedance	+V _{CC} = 18V, -V _{CC} = -18V			2.0	Ω	1
	100 = 100, 000 = 100			4.0	Ω	2, 3
Capacitor Charging Current	+V _{CC} = 8V, -V _{CC} = -28V		-25	-4.5	mA	1
			-25	-3.0	mA	2, 3
	+V _{CC} = 28V, -V _{CC} = -8V		4.5	25	mA	1
	1,000 = 200, 000 = 00		3.0	25	mA	2, 3
ogic Pin Current	$+V_{CC} = 18V$, $-V_{CC} = -18V$, Mode = "Sample", Logic = $7V$			10	μΑ	1, 2, 3
	+V _{CC} = 18V, -V _{CC} = -18V, Mode =			1.0	μA	1
	"Hold", Logic = -30V			0.5	μA	2, 3
nput Offset Voltage	$+V_{CC} = 15V, -V_{CC} = -15V,$		-3.5	3.5	mV	1
	I _{Drive} = +1mA		-6.0	6.0	mV	2, 3
nput Offset Voltage	$+V_{CC} = 15V, -V_{CC} = -15V,$		-1.1	1.1	mV	1
			-2.0	2.0	mV	2, 3
Output Short Circuit Current	+V _{CC} = 18V, -V _{CC} = -18V		7.0	20	mA	1
· ·	$+V_{CC} = 18V, -V_{CC} = -18V$		-25	-7.0	mA	1
Logic Reference Pin Current	$+V_{CC} = 18V, -V_{CC} = -18V, Mode =$		-1.0	1.0	μA	1
	+V _{CC} = 18V, -V _{CC} = -18V, Mode =		-0.5		μΑ	2, 3
np Di	utput Short Circuit Current utput Short Circuit Current	$ +V_{CC} = 18V, -V_{CC} = -18V, \text{ Mode} = \\ \text{"Hold", Logic} = -30V \\ +V_{CC} = 15V, -V_{CC} = -15V, \\ \text{I}_{Drive} = +1\text{mA} \\ \text{out Offset Voltage} \\ +V_{CC} = 15V, -V_{CC} = -15V, \\ \text{I}_{Drive} = +1\text{mA} \text{ to } -1\text{mA} \\ \text{Itput Short Circuit Current} \\ $	$ +V_{CC} = 18V, -V_{CC} = -18V, \text{ Mode} = \\ \text{"Hold", Logic} = -30V \\ +V_{CC} = 15V, -V_{CC} = -15V, \\ I_{Drive} = +1mA \\ +V_{CC} = 15V, -V_{CC} = -15V, \\ I_{Drive} = +1mA \text{ to } -1mA \\ +V_{CC} = 18V, -V_{CC} = -18V, \\ +V_{CC} = 18V, -V_{CC} = -18V \\ +V_{CC} = 18V, -V_{CC} = -18V, \\ +V_{CC} = 18V, -V_{CC} = -18V, \text{ Mode} = \\ \text{"Sample", Logic} = 7V \\ +V_{CC} = 18V, -V_{CC} = -18V, \text{ Mode} = \\ \text{"Sample", Logic} = 7V \\ +V_{CC} = 18V, -V_{CC} = -18V, \text{ Mode} = \\ \text{"Sample", Logic} = 7V \\ +V_{CC} = 18V, -V_{CC} = -18V, \text{ Mode} = \\ \text{"Sample", Logic} = 7V \\ +V_{CC} = 18V, -V_{CC} = -18V, \text{ Mode} = \\ \text{"Sample", Logic} = 7V \\ +V_{CC} = 18V, -V_{CC} = -18V, \text{ Mode} = \\ \text{"Sample", Logic} = 7V \\ +V_{CC} = 18V, -V_{CC} = -18V, \text{ Mode} = \\ \text{"Sample", Logic} = -18V, \text{ Mode} = \\ $			

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⁽²⁾ Hold step is sensitive to stray capacitive coupling between input logic signals and the hold capacitor. 1 pF, for instance, will create an additional 0.5 mV step with a 5V logic swing and a 0.01μF hold capacitor. Magnitude of the hold step is inversely proportional to hold capacitor value.



Electrical Characteristics (continued)

The following specifications apply unless otherwise specified.

 $V_{CC} = \pm 15 \text{V}, \; R_L = 10 \text{K}\Omega, \; V_{\text{IN}} = 0 \text{V}, \; C_{\text{HOLD}} = 0.01 \; \mu\text{F}, \; \text{Logic Reference Pin} = 0 \text{V}, \; \text{Logic Pin} = 4 \text{V}$

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub- groups
PSRR	Power Supply Rejection Ratio			80		dB	1
		$+V_{CC} = 10V, -V_{CC} = -15V$		74		dB	2, 3
				80		dB	1
		$+V_{CC} = 15V, -V_{CC} = -10V$		74		dB	2, 3
FTRR	Feed Through Rejection Ratio			86		dB	1
		$+V_{CC} = 3.5V, -V_{CC} = -32.5V$		74		dB	2, 3
				86		dB	1
		$+V_{CC} = 32.5V, -V_{CC} = -3.5V$		74		dB	2, 3
V _{TH}	Differential Logic Level		See (3)	0.8	2.4	V	1
Vos	2nd Stage V _{OS}	.\\ 2.5\\ \\ 22.5\\		-35	+35	mV	1
(2nd Stg)		$+V_{CC} = 3.5V, -V_{CC} = -32.5V$		-50	+50	mV	2, 3
		.)/ 2)/)/ 7)/		-35	+35	mV	1
		$+V_{CC} = 3V, -V_{CC} = -7V$		-50	+50	mV	2, 3
		.\\ 22.5\\ \\ 2.5\\		-35	+35	mV	1
		$+V_{CC} = 32.5V, -V_{CC} = -3.5V$		-50	+50	mV	2, 3
		.)/ 7)/)/ 2)/		-35	+35	mV	1
		$+V_{CC} = 7V, -V_{CC} = -3V$		-50	+50	mV	2, 3

⁽³⁾ Parameter tested go no go only for Vth test.

AC Parameters

The following specifications apply unless otherwise specified.

 $V_{CC} = \pm 15V$, $R_L = 10K\Omega$, $V_{IN} = 0V$, $C_{Hold} = 0.01~\mu F$, Logic Reference Pin = 0V, Logic Pin = 4V

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub- groups
T_{AQ}	Acquisition Time	Delta V _{OUT} = 10V, C _{Hold} = 1000pF			6.0	μS	4
		Delta $V_{OUT} = 10V$, $C_{Hold} = 0.01\mu F$			25	μS	4

DC Parameters: Drift Values

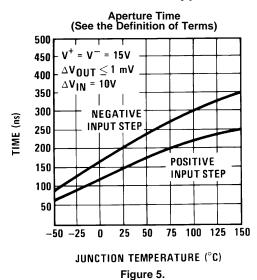
The following conditions apply to all the following parameters, unless otherwise specified. V_{CC} = ±15V, R_L = 10K Ω , V_{IN} = 0V, C_{Hold} = 0.01 μ F, Logic Reference Pin = 0V, Logic Pin = 4V Deltas required for S-Level product ONLY.

Symbol	Parameters	Conditions	Notes	Min	Max	Unit	Sub- groups
Vos	Input Offset Voltage	$+V_{CC} = 15V, -V_{CC} = -15V$		-0.5	0.5	mV	1
I_{IB}	Input Bias Current	+V _{CC} = 15V, -V _{CC} = -15V		-2.5	2.5	nA	1

Product Folder Links: LF198QML



Typical Performance Characteristics



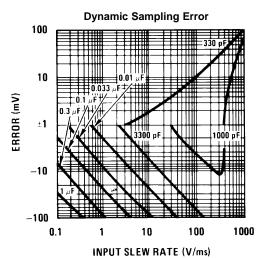
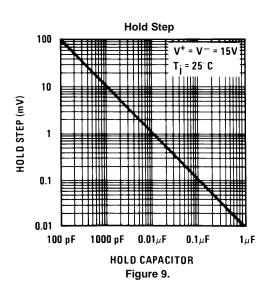
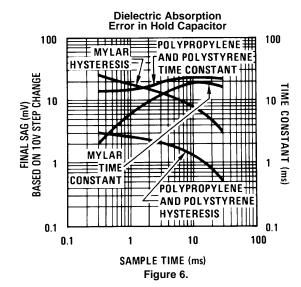
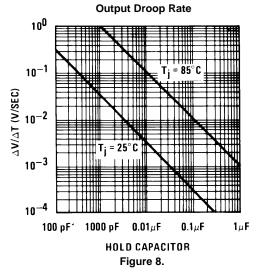
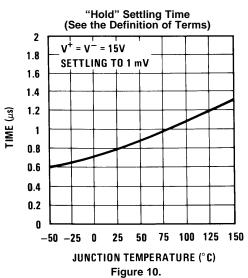


Figure 7.



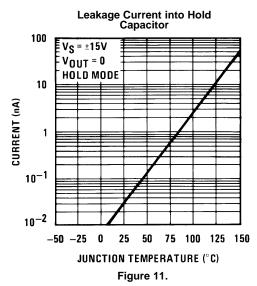


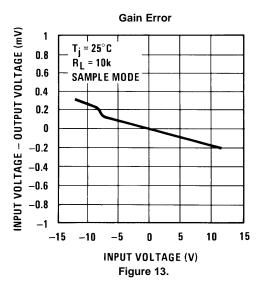


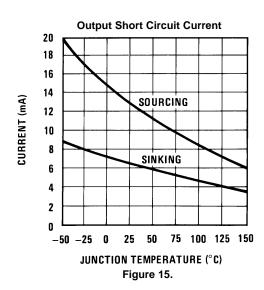


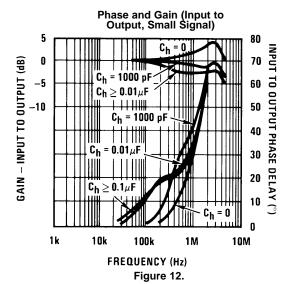


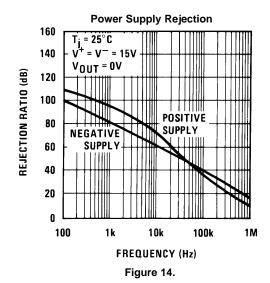
Typical Performance Characteristics (continued)







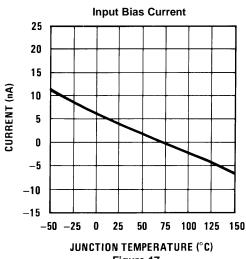


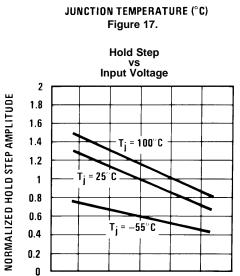


Output Noise (See the Definition of Terms) 160 140 120 "HOLD" NOISE (nV/√Hz) 100 MODE 80 60 40 SAMPLE MODE 20 0 100 10 1k 10k 100k FREQUENCY (Hz) Figure 16.



Typical Performance Characteristics (continued)



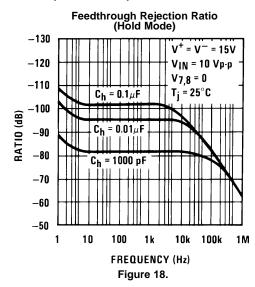


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INPUT VOLTAGE (V) Figure 19.

10

15



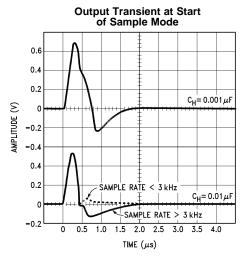
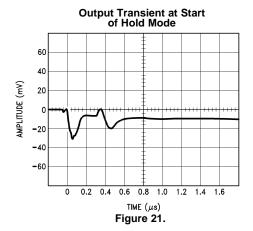


Figure 20.



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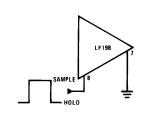
-15

-10

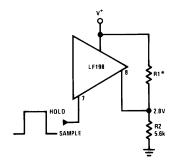


Logic Input Configurations

TTL & CMOS $3V \le V_{LOGIC}$ (Hi State) $\le 7V$

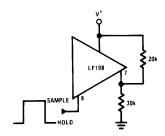


Threshold = 1.4V

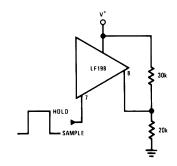


Threshold = 1.4V*Select for 2.8V at pin 8

CMOS 7V ≤ V_{LOGIC} (Hi State) ≤ 15V

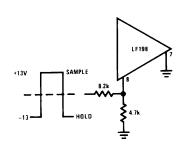


Threshold = $0.6 (V^+) + 1.4V$

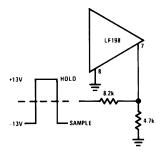


Threshold = $0.6 (V^+) - 1.4V$

Op Amp Drive



Threshold ≈ +4V



Threshold = -4V



APPLICATION INFORMATION

HOLD CAPACITOR

Hold step, acquisition time, and droop rate are the major trade-offs in the selection of a hold capacitor value. Size and cost may also become important for larger values. Use of the curves included with this data sheet should be helpful in selecting a reasonable value of capacitance. Keep in mind that for fast repetition rates or tracking fast signals, the capacitor drive currents may cause a significant temperature rise in the LF198.

A significant source of error in an accurate sample and hold circuit is dielectric absorption in the hold capacitor. A mylar cap, for instance, may "sag back" up to 0.2% after a quick change in voltage. A long sample time is required before the circuit can be put back into the hold mode with this type of capacitor. Dielectrics with very low hysteresis are polystyrene, polypropylene, and Teflon. Other types such as mica and polycarbonate are not nearly as good. The advantage of polypropylene over polystyrene is that it extends the maximum ambient temperature from 85°C to 100°C. Most ceramic capacitors are unusable with > 1% hysteresis. Ceramic "NPO" or "COG" capacitors are now available for 125°C operation and also have low dielectric absorption. For more exact data, see the curve Dielectric Absorption Error. The hysteresis numbers on the curve are final values, taken after full relaxation. The hysteresis error can be significantly reduced if the output of the LF198 is digitized quickly after the hold mode is initiated. The hysteresis relaxation time constant in polypropylene, for instance, is 10—50 ms. If A-to-D conversion can be made within 1 ms, hysteresis error will be reduced by a factor of ten.

DC AND AC ZEROING

DC zeroing is accomplished by connecting the offset adjust pin to the wiper of a 1 k Ω potentiometer which has one end tied to V⁺ and the other end tied through a resistor to ground. The resistor should be selected to give ≈0.6 mA through the 1k potentiometer.

AC zeroing (hold step zeroing) can be obtained by adding an inverter with the adjustment pot tied input to output. A 10 pF capacitor from the wiper to the hold capacitor will give ±4 mV hold step adjustment with a 0.01 µF hold capacitor and 5V logic supply. For larger logic swings, a smaller capacitor (< 10 pF) may be used.

LOGIC RISE TIME

For proper operation, logic signals into the LF198 must have a minimum dV/dt of 1.0 V/µs. Slower signals will cause excessive hold step. If a R/C network is used in front of the logic input for signal delay, calculate the slope of the waveform at the threshold point to ensure that it is at least 1.0 V/us.

SAMPLING DYNAMIC SIGNALS

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Sample error to moving input signals probably causes more confusion among sample-and-hold users than any other parameter. The primary reason for this is that many users make the assumption that the sample and hold amplifier is truly locked on to the input signal while in the sample mode. In actuality, there are finite phase delays through the circuit creating an input-output differential for fast moving signals. In addition, although the output may have settled, the hold capacitor has an additional lag due to the 300Ω series resistor on the chip. This means that at the moment the "hold" command arrives, the hold capacitor voltage may be somewhat different than the actual analog input. The effect of these delays is opposite to the effect created by delays in the logic which switches the circuit from sample to hold. For example, consider an analog input of 20 Vp-p at 10 kHz. Maximum dV/dt is 0.6 V/µs. With no analog phase delay and 100 ns logic delay, one could expect up to (0.1 μs)(0.6V/μs)= 60 mVerror if the "hold" signal arrived near maximum dV/dt of the input. A positive-going input would give a +60 mV error. Now assume a 1 MHz (3 dB) bandwidth for the overall analog loop. This generates a phase delay of 160 ns. If the hold capacitor sees this exact delay, then error due to analog delay will be (0.16 μs) (0.6 V/µs) = -96 mV. Total output error is +60 mV (digital) -96 mV (analog) for a total of -36 mV. To add to the confusion, analog delay is proportioned to hold capacitor value while digital delay remains constant. A family of curves (dynamic sampling error) is included to help estimate errors.

A curve labeled Aperture Time has been included for sampling conditions where the input is steady during the sampling period, but may experience a sudden change nearly coincident with the "hold" command. This curve is based on a 1 mV error fed into the output.

A second curve, Hold Settling Time indicates the time required for the output to settle to 1 mV after the "hold" command.

Product Folder Links: LF198QML



DIGITAL FEEDTHROUGH

Fast rise time logic signals can cause hold errors by feeding externally into the analog input at the same time the amplifier is put into the hold mode. To minimize this problem, board layout should keep logic lines as far as possible from the analog input and the C_h pin. Grounded guarding traces may also be used around the input line, especially if it is driven from a high impedance source. Reducing high amplitude logic signals to 2.5V will also help.

Guarding Technique

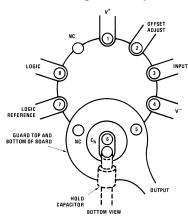


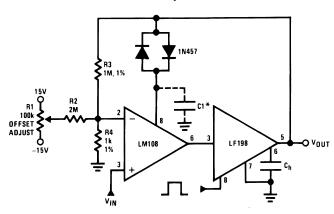
Figure 22. Use 10-pin layout. Guard around Chis tied to output.

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Typical Applications

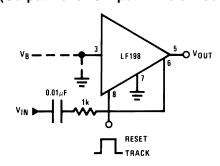
X1000 Sample & Hold



*For lower gains, the LM108 must be frequency compensated

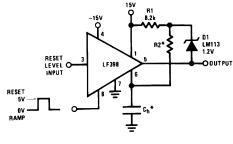
Use $\approx \frac{100}{\text{Av}} \text{ pF from comp 2 to ground}$

Sample and Difference Circuit (Output Follows Input in *Hold* Mode)



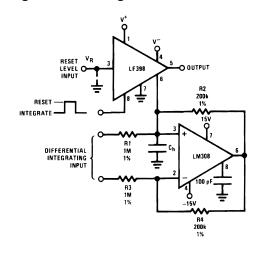
 $V_{OUT} = V_B + \Delta V_{IN}(HOLD MODE)$

Ramp Generator with Variable Reset Level



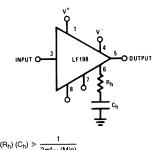
*Select for ramp rate $\frac{\Delta V}{\Delta T} = \frac{1.2V}{(R2) (C_h)}$

Integrator with Programmable Reset Level

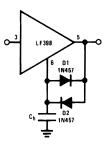


$$V_{OUT}$$
 (Hold Mode) = $\left[\frac{1}{(R1)(C_h)}\int_0^t V_{IN} dt\right] + \left[V_R\right]$

Output Holds at Average of Sampled Input



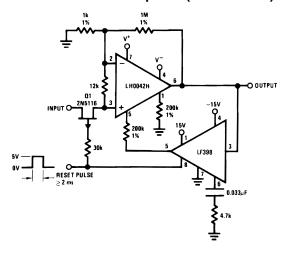
Increased Slew Current



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Reset Stabilized Amplifier (Gain of 1000)



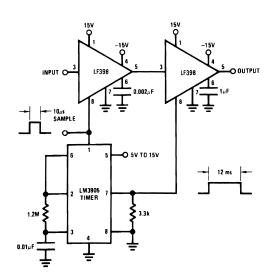
 $V_{OS}\,\leq\,20\mu V$ (No trim)

 $Z_{\text{IN}} \approx$ 1 M Ω

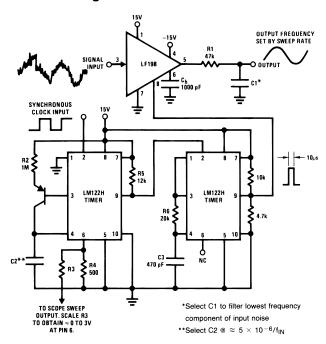
 $\frac{\Delta V_{OS}}{\Delta t} \approx 30 \mu \text{V/sec}$

 $\frac{\Delta V_{OS}}{\Delta T} \approx \, 0.1 \mu V/^{\circ} C$

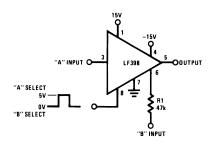
Fast Acquisition, Low Droop Sample & Hold



Synchronous Correlator for Recovering Signals Below Noise Level



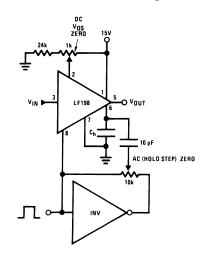
2-Channel Switch



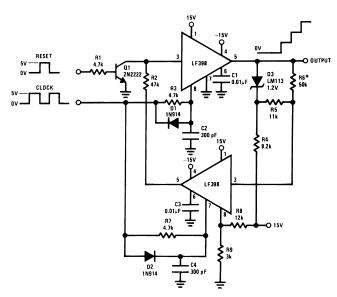


	Α	В
Gain	1 ± 0.02%	1 ± 0.2%
Z _{IN}	10 ¹⁰ Ω	47 kΩ
BW	≃ 1 MHz	≃ 400 kHz
Crosstalk	-90 dB	-90 dB
@ 1 kHz		
Offset	≤ 6 mV	≤ 75 mV

DC & AC Zeroing

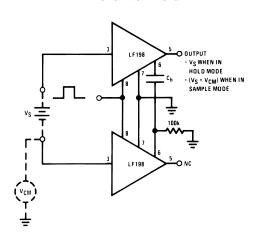


Staircase Generator

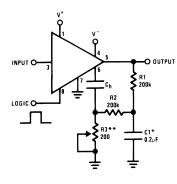


*Select for step height $50k \rightarrow \cong 1V$ Step

Differential Hold



Capacitor Hysteresis Compensation



*Select for time constant C1 = $\frac{\tau}{100k}$

**Adjust for amplitude



Definition of Terms

Hold Step: The voltage step at the output of the sample and hold when switching from sample mode to hold mode with a steady (dc) analog input voltage. Logic swing is 5V.

Acquisition Time: The time required to acquire a new analog input voltage with an output step of 10V. Note that acquisition time is not just the time required for the output to settle, but also includes the time required for all internal nodes to settle so that the output assumes the proper value when switched to the hold mode.

Gain Error: The ratio of output voltage swing to input voltage swing in the sample mode expressed as a per cent difference.

Hold Settling Time: The time required for the output to settle within 1 mV of final value after the "hold" logic command.

Dynamic Sampling Error: The error introduced into the held output due to a changing analog input at the time the hold command is given. Error is expressed in mV with a given hold capacitor value and input slew rate. Note that this error term occurs even for long sample times.

Aperture Time: The delay required between "Hold" command and an input analog transition, so that the transition does not affect the held output.

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REVISION HISTORY SECTION

Date Released	Revision	Section	Originator	Changes
02/25/05	А	New release, Corporate format	L. Lytle	1 MDS converted to corp. datasheet format. MNLF198–X Rev 3B0 MDS to be archived. Change has been made to Electrical Section, Parameter I _{OS} Max limit was 7.0 now is –7.0 confirmed with SG. Added note Parameter tested go no go to V _{TH} test.
03/20/2013	А	All Sections		Changed Layout of National Data Sheet to TI format

Product Folder Links: LF198QML

www.ti.com 30-Sep-2021

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-8760801GA	ACTIVE	TO-99	LMC	8	20	Non-RoHS & Non-Green	Call TI	Call TI	-55 to 125	LF198H/883 5962-8760801GA Q A CO 5962-8760801GA Q > T	Samples
5962-8760801VZA	ACTIVE	CFP	NAC	14	42	Non-RoHS & Green	Call TI	Level-1-NA-UNLIM	-55 to 125	LF198WG- QMLV Q 5962-87608 01VZA ACO 01VZA >T	Samples
LF198H/883	ACTIVE	TO-99	LMC	8	20	Non-RoHS & Non-Green	Call TI	Call TI	-55 to 125	LF198H/883 5962-8760801GA Q A CO 5962-8760801GA Q > T	Samples
LF198WG-QMLV	ACTIVE	CFP	NAC	14	42	Non-RoHS & Green	Call TI	Level-1-NA-UNLIM	-55 to 125	LF198WG- QMLV Q 5962-87608 01VZA ACO 01VZA >T	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

PACKAGE OPTION ADDENDUM

www.ti.com 30-Sep-2021

- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF LF198QML, LF198QML-SP:

Military: LF198QML

Space : LF198QML-SP

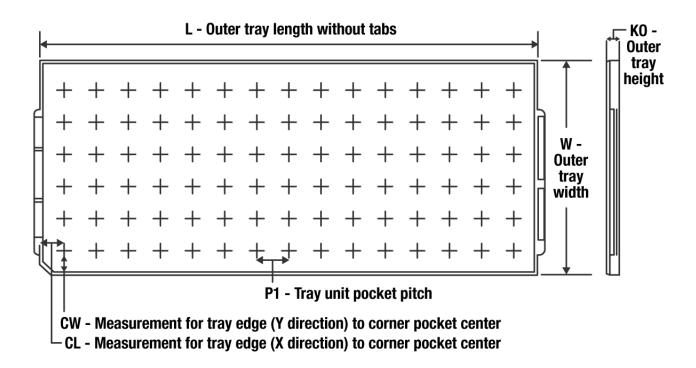
NOTE: Qualified Version Definitions:

- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application



www.ti.com 5-Jan-2022

TRAY



Chamfer on Tray corner indicates Pin 1 orientation of packed units.

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)	W (mm)	Κ0 (μm)	P1 (mm)	CL (mm)	CW (mm)
5962-8760801GA	LMC	TO-CAN	8	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
5962-8760801VZA	NAC	CFP	14	42	7 X 6	NA	101.6	101.6	8001	2.84	15.24	15.24
LF198H/883	LMC	TO-CAN	8	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
LF198WG-QMLV	NAC	CFP	14	42	7 X 6	NA	101.6	101.6	8001	2.84	15.24	15.24

LMC (O-MBCY-W8)

METAL CYLINDRICAL PACKAGE



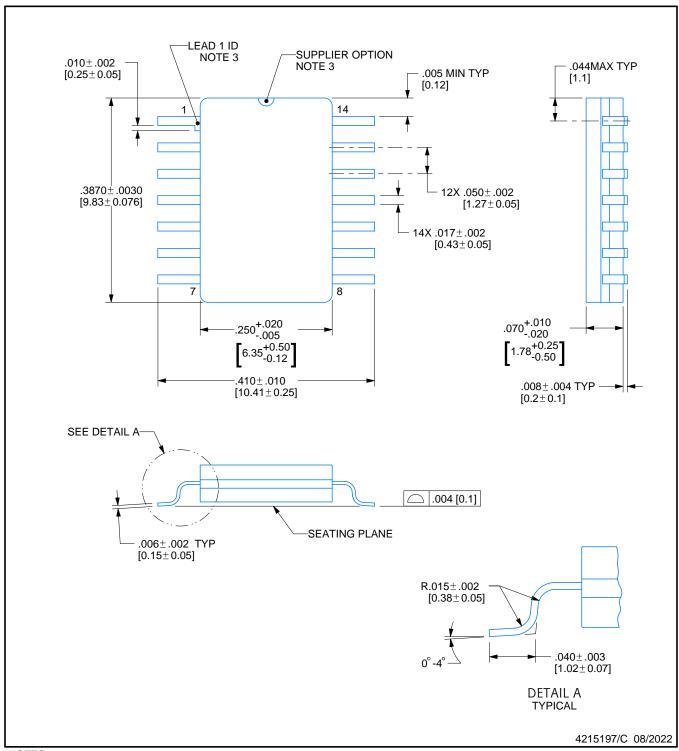
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Leads in true position within 0.010 (0,25) R @ MMC at seating plane.
- D. Pin numbers shown for reference only. Numbers may not be marked on package.
- E. Falls within JEDEC MO-002/TO-99.





CERAMIC FLATPACK

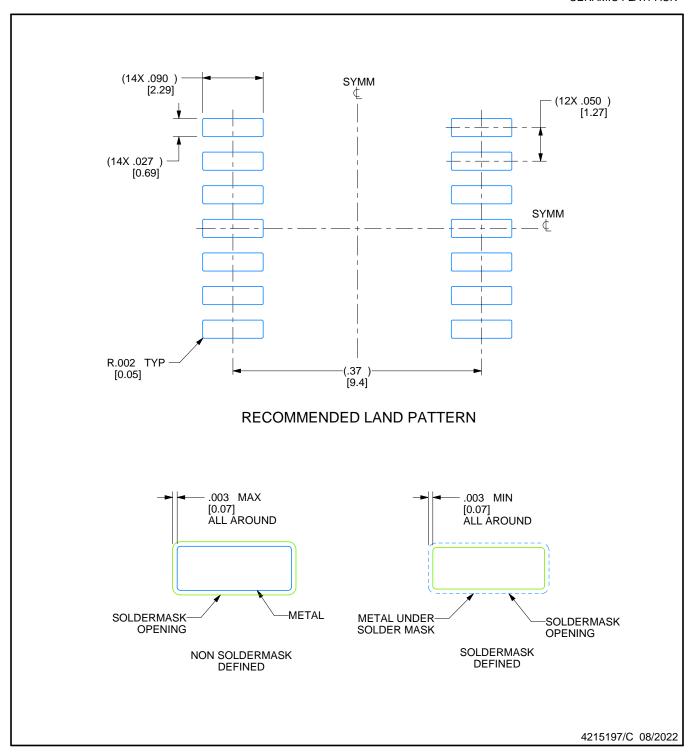


NOTES:

- 1. Controlling dimension is Inch. Values in [] are milimeters. Dimensions in () for reference only.
 2. For solder thickness and composition, see the "Lead Finish Composition/Thickness" link in the packaging section of the Texas Instruments website
- 3. Lead 1 identification shall be:
 - a) A notch or other mark within this area
 - b) A tab on lead 1, either side
- 4. No JEDEC registration as of December 2021



CERAMIC FLATPACK





		REVISION			
REV	DESCRIPTION		E.C.N.	DATE	BY/APP'D
Α	RELEASE TO DOCUMENT CONTROL		2197878	12/30/2021	DAVID CHIN / ANIS FAUZI
В	NO CHANGE TO DRAWING; REVISION FOR YODA RELEASE;		2198833	02/15/2022	K. SINCERBOX
С	.3870± .0030 WAS .39000± .00012;		2200916	08/08/2022	D. CHIN / K. SINCERBOX
C			2200916	08/08/2022	D. CHIN / K. SINCERBOX
					l and l
		SCALE SIZE A		42151	97 REV PAGE 4 OF 4

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